

# *Structural and electrical properties in superconducting $\text{Sr}_{0.85}\text{La}_{0.15}\text{CuO}_2$ -based nanostructures*

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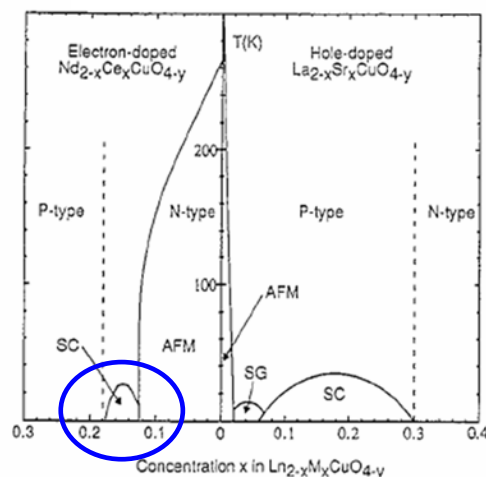
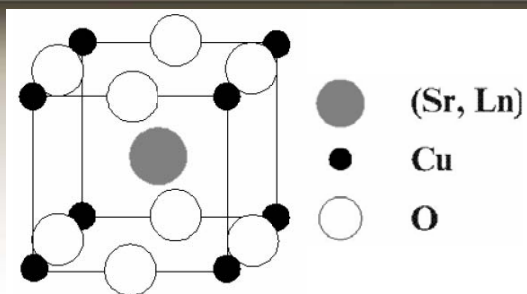
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# Outline

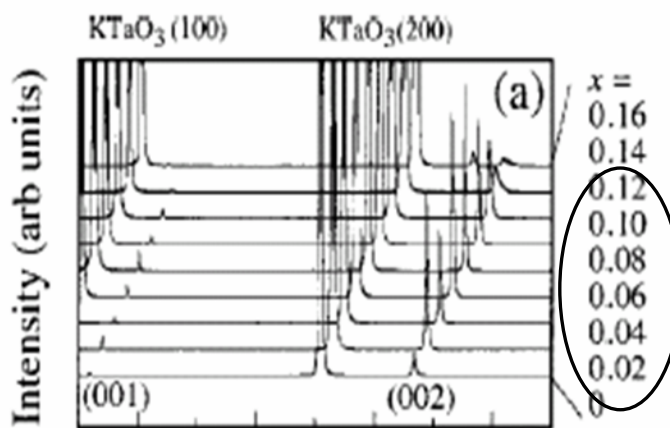
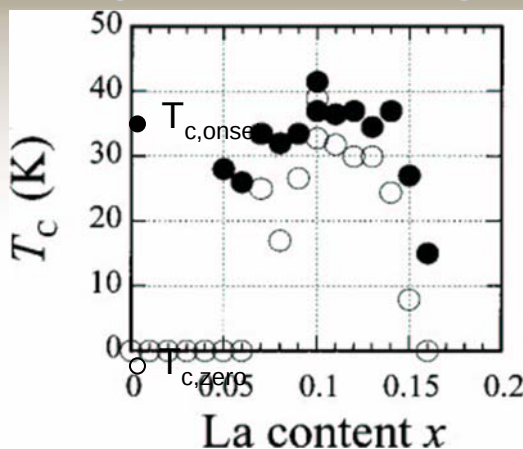
1. Experimental motivation of the work - the electron-doped infinite-layer type  $\text{Sr}_{1-x}\text{La}_x\text{CuO}_2$  high  $T_c$  superconductors
2.  $\text{Sr}_{1-x}\text{La}_x\text{CuO}_2$  ( $x=0.10-0.20$ ) thin films: PLD growth by the reduction method and characterization
3. Grain boundary  $\text{Sr}_{1-x}\text{La}_x\text{CuO}_2$  ( $x=0.15$ ) Josephson junctions
4. Preliminary results on the  $\text{Sr}_{1-x}\text{La}_x\text{CuO}_2/\text{Au}/\text{Nb}$  ramp-type junctions
5. Conclusions

# The $\text{Sr}_{1-x}\text{La}_x\text{CuO}_2$ (SLCO) compounds



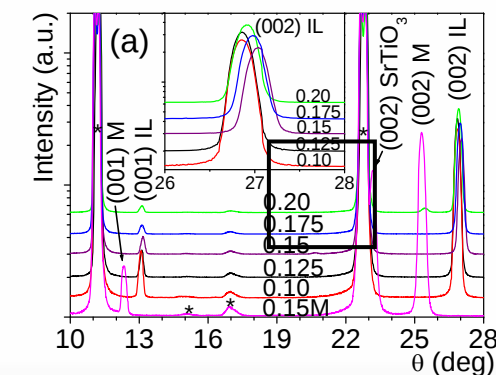
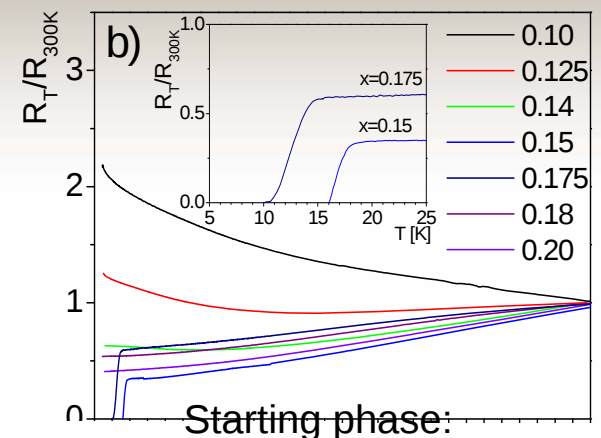
$T_c$  vs. dopant concentration phase diagram for  $T'\text{-Ln}_{2-x}\text{Me}_x\text{CuO}_4$

MBE growth on (001)  $\text{KTaO}_3$   
(reduction method)



Karimoto et al.  
*Appl. Phys. Lett.* 79 (2001)

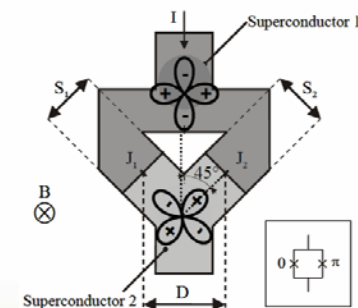
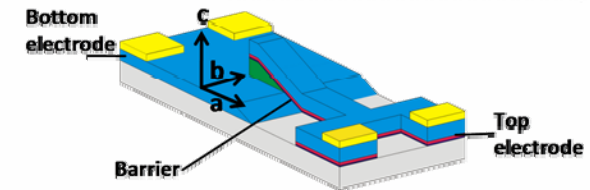
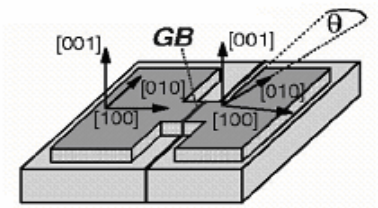
PLD growth on (001)  $\text{KTaO}_3$   
(oxidation method)



Leca et al.  
*Appl. Phys. Lett.* 89 (2006)

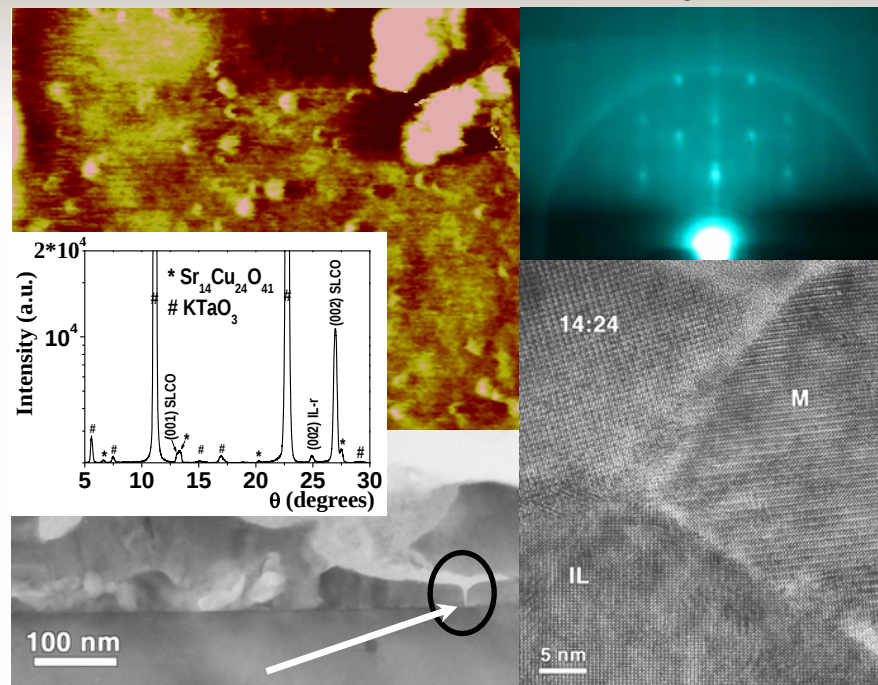
# Motivation of the work

1. Studies on the  $Sr_{1-x}La_xCuO_2$  ( $x=0.10-0.175$ ) thin films: growth and characterization; PLD growth of SLCO thin films on different substrates: (001)  $SrTiO_3$ , (001)  $KTaO_3$ , and (110)  $DyScO_3$  – role of the epitaxial strain on structural and transport properties
2. Fabrication of the grain-boundary Josephson junctions on  $BaTiO_3$  buffered  $SrTiO_3$  and studies of their transport properties (for  $x=0.125-0.15$ )
3. Development of the ramp-type  $Sr_{1-x}La_xCuO_2/Me/Nb$  ( $Me=Ag, Au$ ) Josephson junction technology and studies on junctions transport properties (for  $x>0.15$ )
4. Studies on the order parameter symmetry – based on GB (tetracystal) or ramp-type Josephson junctions for different La doping levels ( $x=0.10-0.175$ ) and temperatures ( $2\text{ K}-T_c$ )



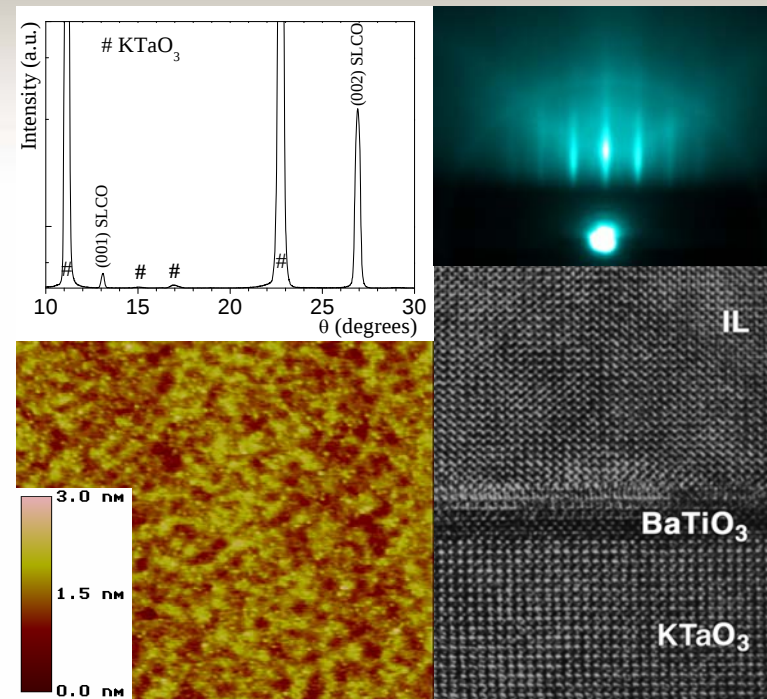
# Role of the substrate-film interface

$\text{Sr}_{1-x}\text{La}_x\text{CuO}_2$  grown on  
as-received (001)  $\text{KTaO}_3$



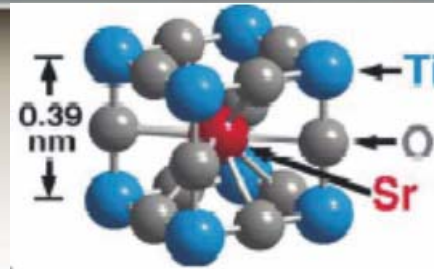
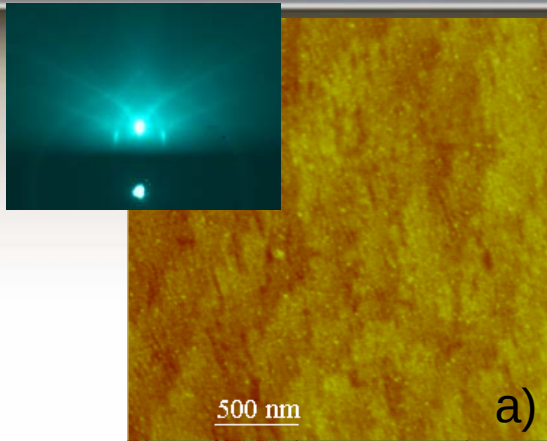
*XRD, HRTEM: Structural defects/secondary  
phases developing at the substrate-film interface  
RHEED, AFM: 3D growth mode induced by the  
high interface roughness*

$\text{Sr}_{1-x}\text{La}_x\text{CuO}_2$  grown on  
 $\text{BaTiO}_3$ -buffered (001)  $\text{KTaO}_3$

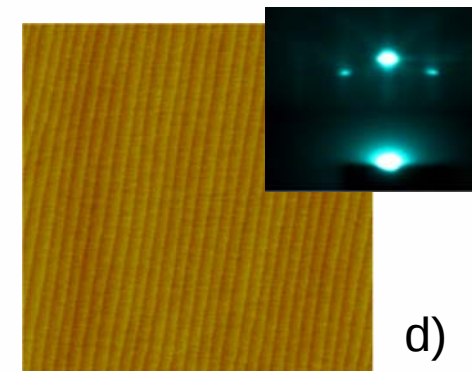
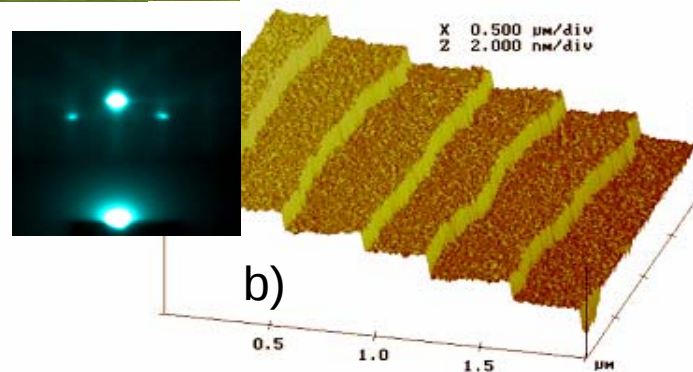
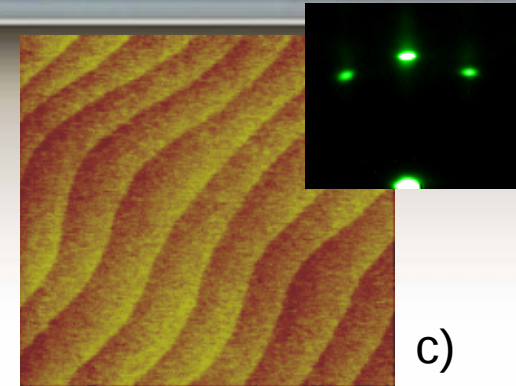


*XRD, HRTEM, AFM: single-phase,  
lower density of structural defects,  
improved morphology  
RHEED, AFM: 2D growth mode*

# Substrate morphology – $\text{SrTiO}_3$



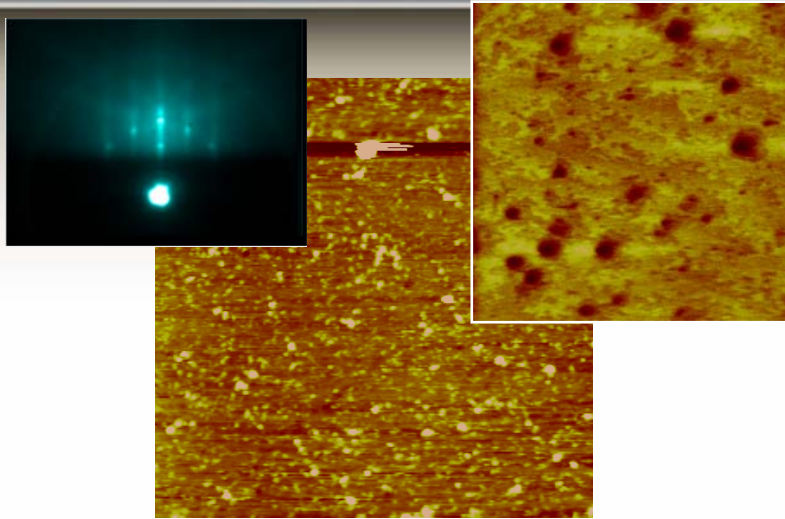
$\text{SrTiO}_3$  structure



- a) as-received substrate
- b) after chemical treatment (BHF) and annealing ( $950^\circ\text{C}/1\text{h}/\text{O}_2$ ) -  $\text{TiO}_2$  termination
- c) after annealing ( $950^\circ\text{C}/1\text{h}/\text{O}_2$ ) -  $\text{SrO}$  termination
- d) after chemical treatment (BHCl) and annealing ( $950^\circ\text{C}/1\text{h}/\text{O}_2$ )- $\text{TiO}_2$  termination (high miscut angle case)

Kawasaki et al. Science 226 (1994)  
Koster et al. Appl. Phys. Lett 73 (1998)  
Leca, PhD thesis (2003)

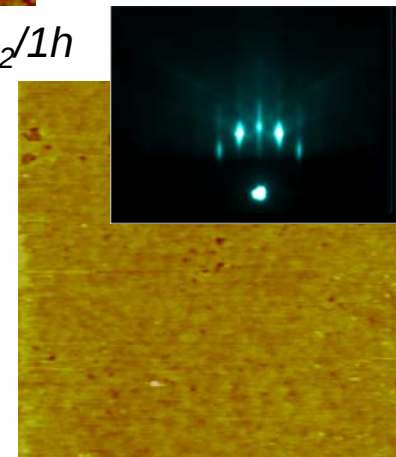
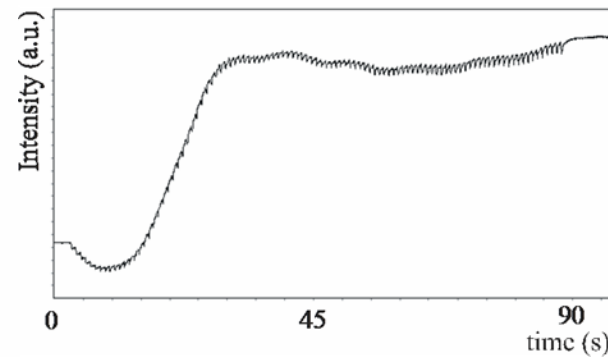
# Substrate morphology – $\text{KTaO}_3$



*as-received substrate*

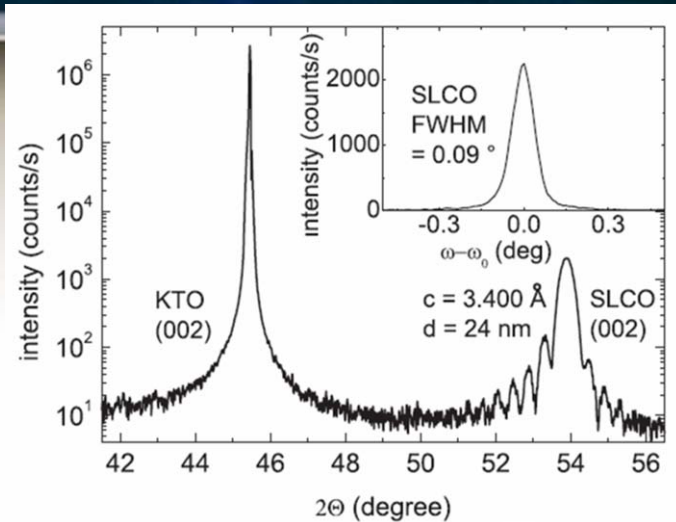
*$\text{KTaO}_3$ : new methods required*

*after annealing at  $750^\circ\text{C}/\text{O}_2/1\text{h}$*



*“surface healing”:  $\text{BaTiO}_3$  on  $\text{KTaO}_3$  –  
RHEED intensity evolution and AFM of the resulted surface*

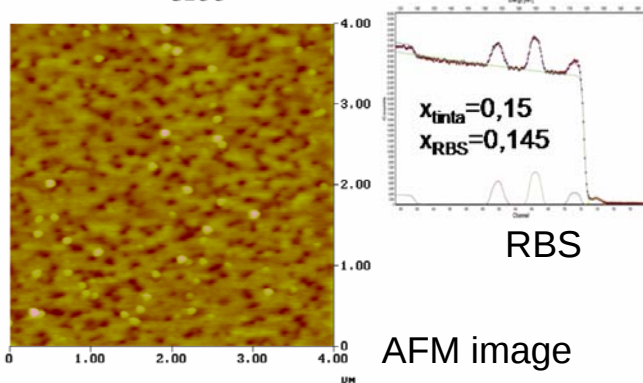
# $Sr_{1-x}La_xCuO_2$ ( $x=0.15$ ) grown on $KTaO_3$ (001)



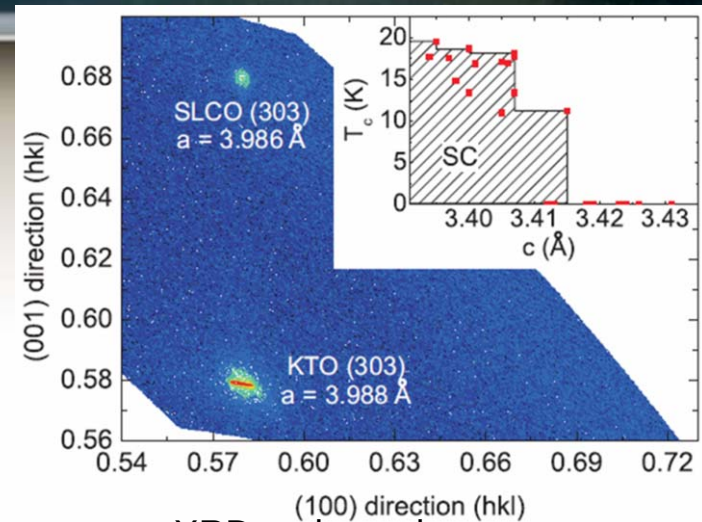
2θ/ω XRD scan of (002) SLCO/KTO

$$a_{SLCO} \sim 3.978-3.988 \text{ Å}$$

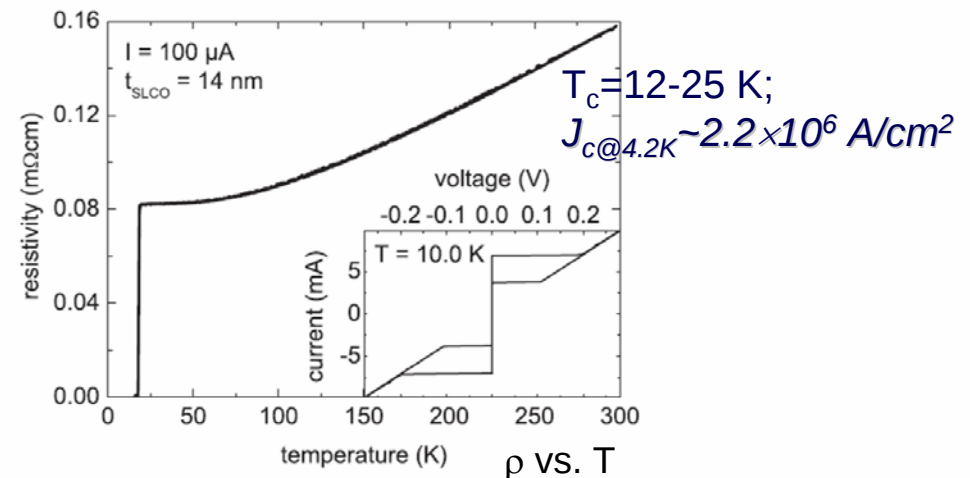
$$c_{SLCO} \sim 3.395-3.405 \text{ Å}$$



AFM image



XRD reciprocal space map

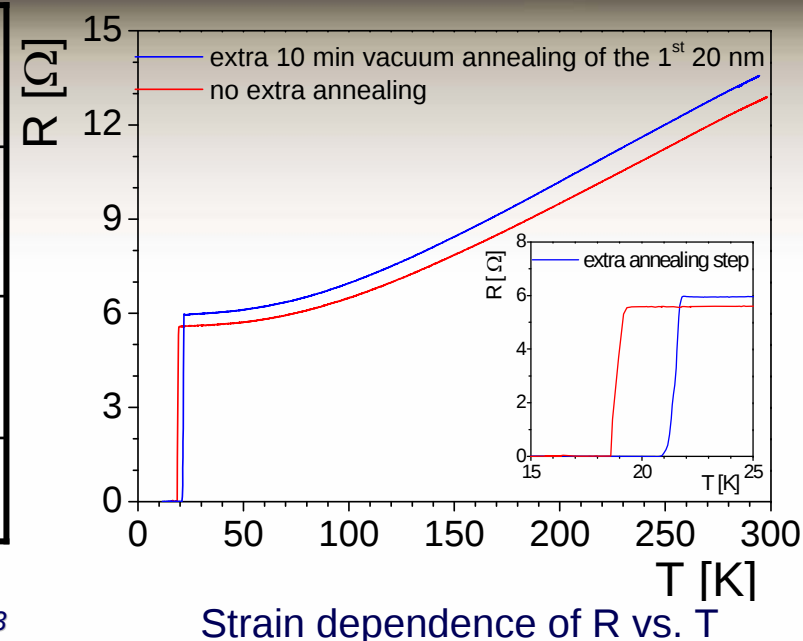
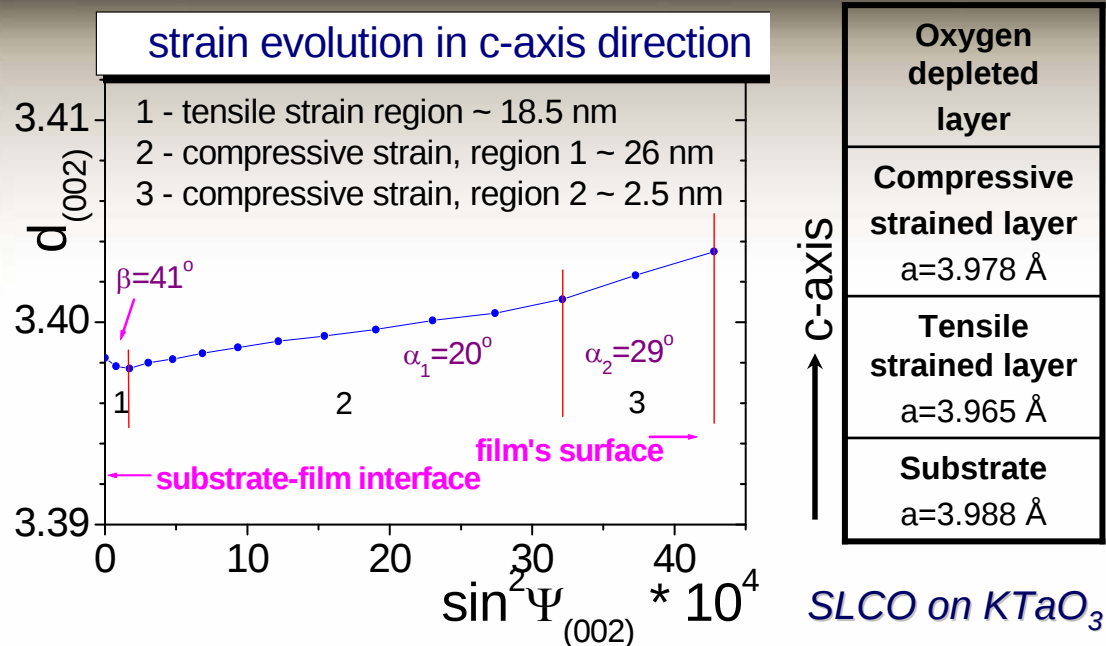


Growth parameters:

$Sr_{0.85}La_{0.15}CuO_2$  (SLCO):  $T_d=575^\circ\text{C}$ ,  $P_d=0.30$  mbar  $O_2$ ;  $E_d=2$  J/cm<sup>2</sup>; 20 min/550°C/10<sup>-7</sup> mbar  
films thickness: 15-50 nm;

*Tomaschko, Leca, Selistrovski, Diebold,  
Jochum, Kleiner, Koelle, Physical Review B 85 (2012)*

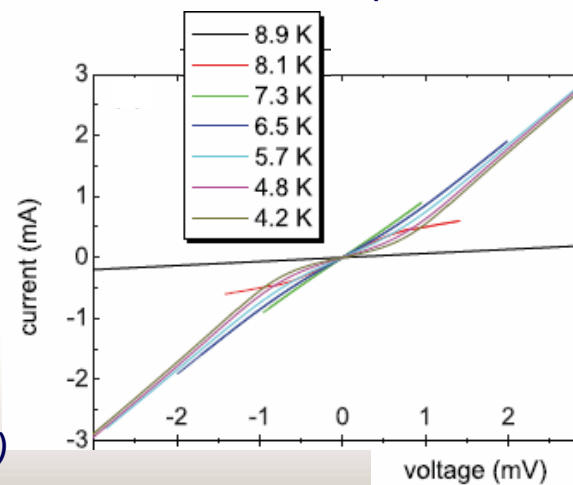
# Role of the epitaxial strain



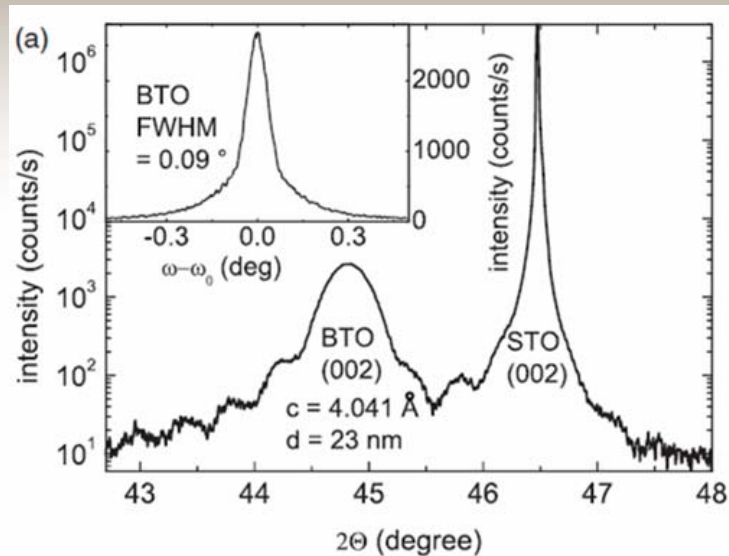
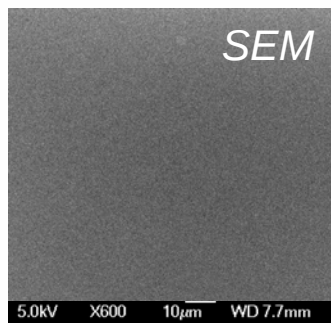
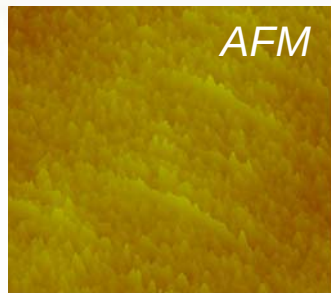
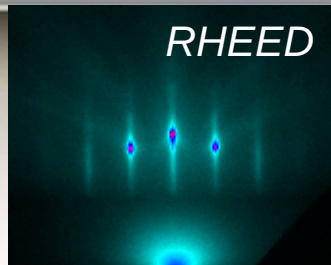
**XRD and XPS:** existence of an oxygen depleted top layer;  
 - implications: no Copper pair tunneling in planar  
 SLCO/Au/Nb junctions

**XRD:** two types of strain: tensile (@ substrate-film interface) and compressive, on top

Tomaschko et al., PRB 84 (2011)

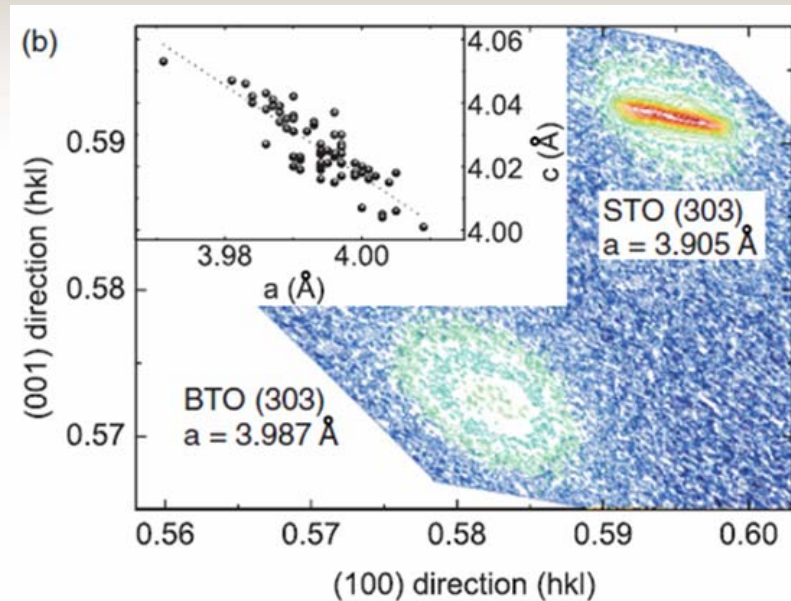


# $Sr_{1-x}La_xCuO_2$ ( $x=0.15$ ) grown on $BaTiO_3/SrTiO_3$ (001)



$2\theta/\omega$  XRD scan of (002) BTO/STO

## The $BaTiO_3$ buffer layer



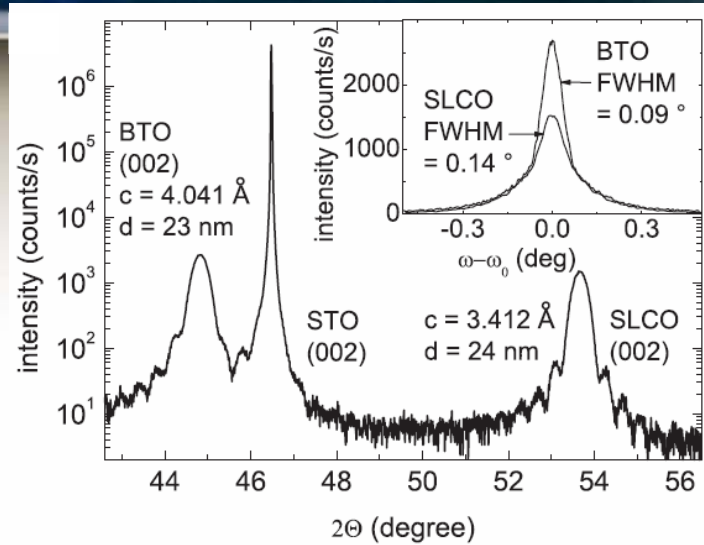
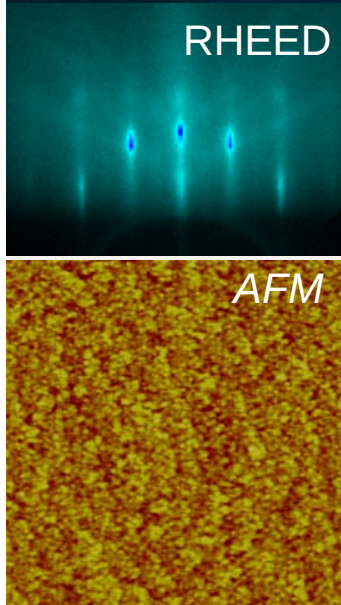
XRD rsm of (303) BTO/STO

Deposition conditions for  $BaTiO_3$ :

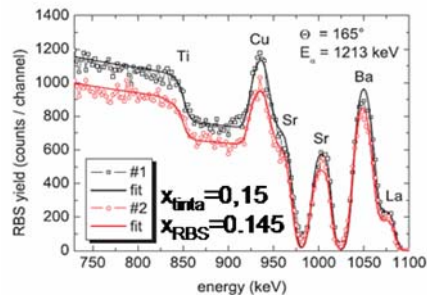
$T_d = 750^\circ\text{C}$ ,  $P_d = 0.10 \text{ mbar O}_2$ ,  $E_d = 1.75 \text{ J/cm}^2$ ; 30 min/ $950^\circ\text{C}/10^{-7} \text{ mbar}$

Tomaschko, Leca, Selistrovski, Diebold,  
 Jochum, Kleiner, Koelle, Phys. Rev. B 85 (2012)

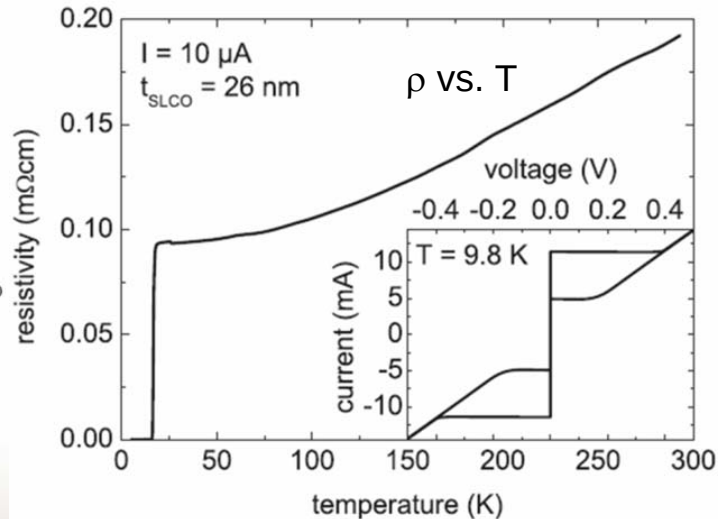
# $Sr_{1-x}La_xCuO_2$ ( $x=0.15$ ) grown on $BaTiO_3/SrTiO_3$ (001)



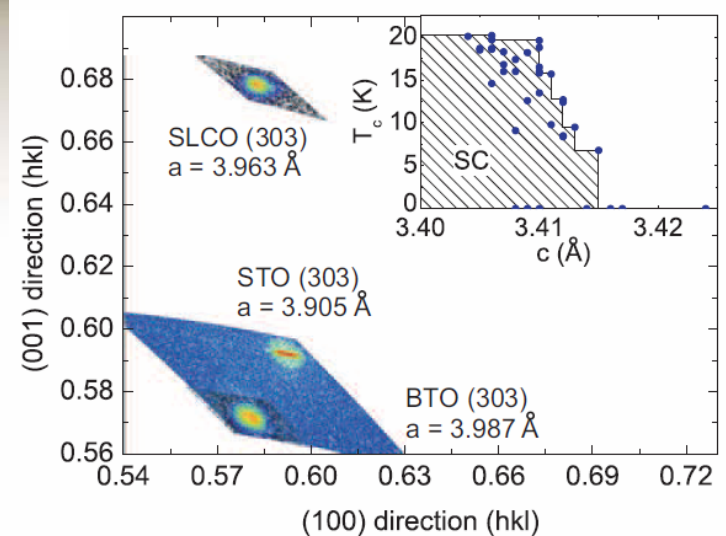
2 $\theta$ / $\omega$  XRD scan of (002) planes



RBS



## $Sr_{1-x}La_xCuO_2$ films



XRD rsm of (303) SLCO/BTO/STO

### Deposition conditions:

$T_d = 550^\circ\text{C}$ ,  $0.40 \text{ mbar O}_2$ ;

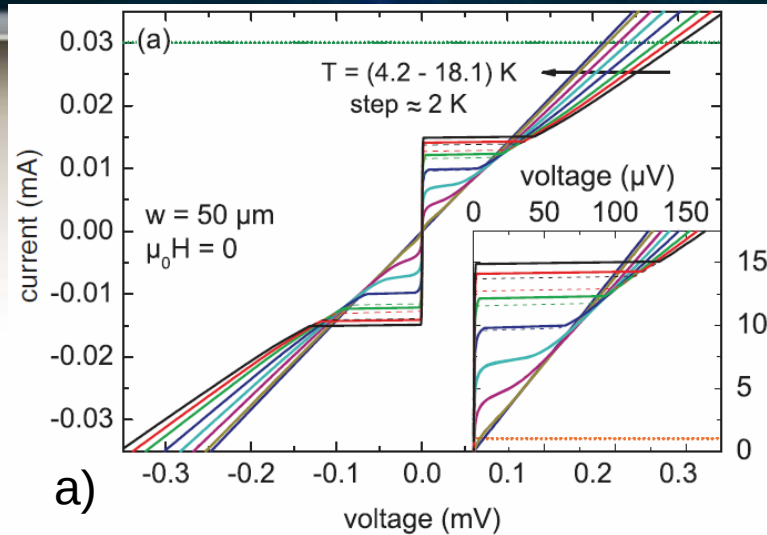
$50 \text{ min}/550^\circ\text{C}/10^{-7} \text{ mbar}$

$T_{c,0} = 12\text{--}21 \text{ K}$

$J_{c@4.2K} = 2.1 \times 10^6 \text{ A/cm}^2$

Tomaschko, Leca, Selistrovski, Diebold,  
Jochum, Kleiner, Koelle, Phys. Rev. B 85 (2012)

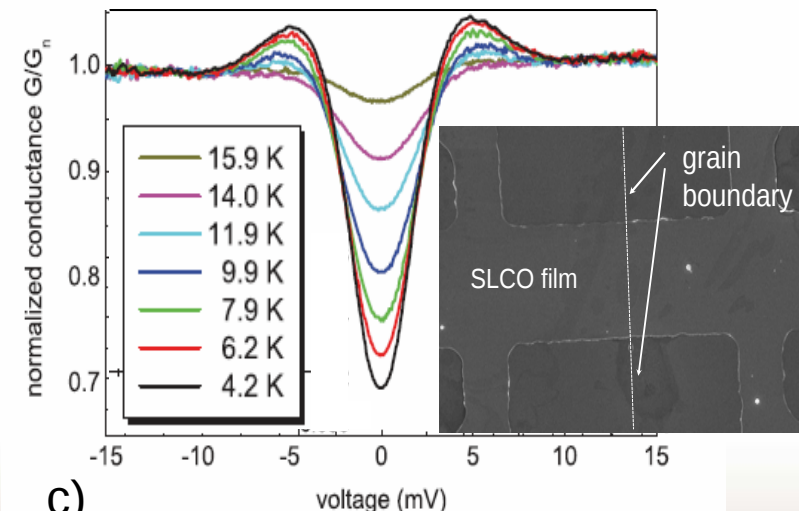
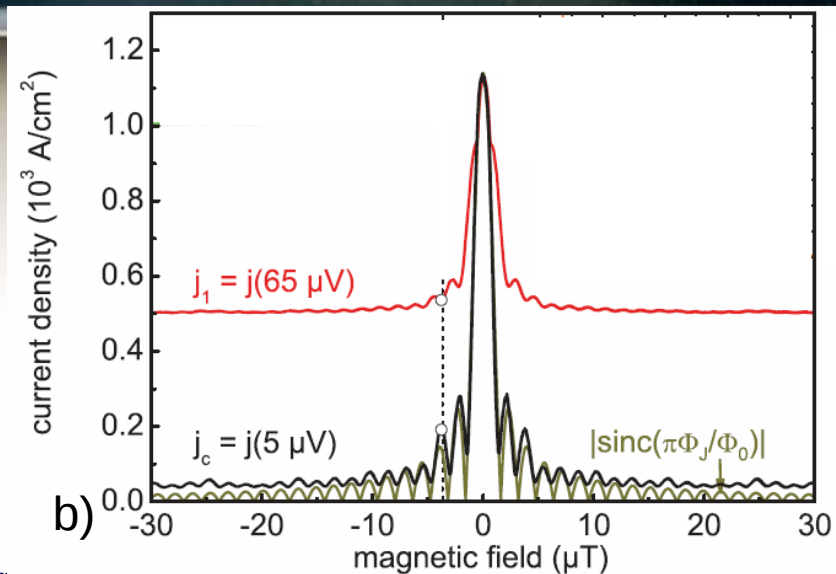
# $Sr_{1-x}La_xCuO_2$ 24° symmetric grain boundary junctions



a) ICVs: resistively and capacitively shunted junction (RCSJ)-like, with no significant excess current;  
 -  $J_c$  (@ 4.2 K)  $\sim 1.2 \text{ kA/cm}^2$  – 1-2 orders of magnitude above  $J_c$  of 24° GB based on NCCO and LCCO

b) highly regular Fraunhofer-like patterns for different voltage criterion

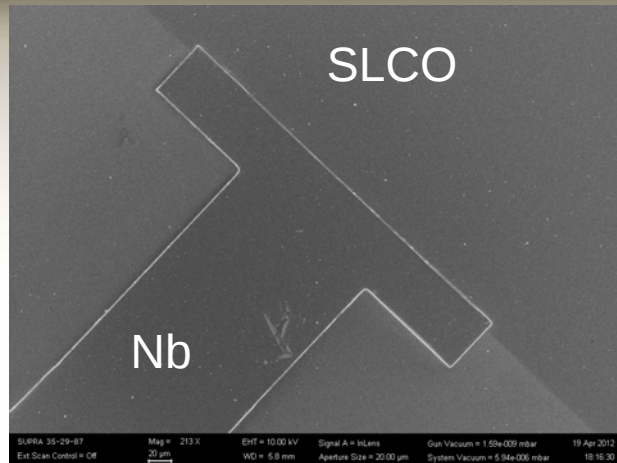
c) conductance spectra did not show a zero-bias conductance peak. s-wave symmetry?  
 but the V-shaped of the spectra in the subgap regime may indicate an order parameter with nodes



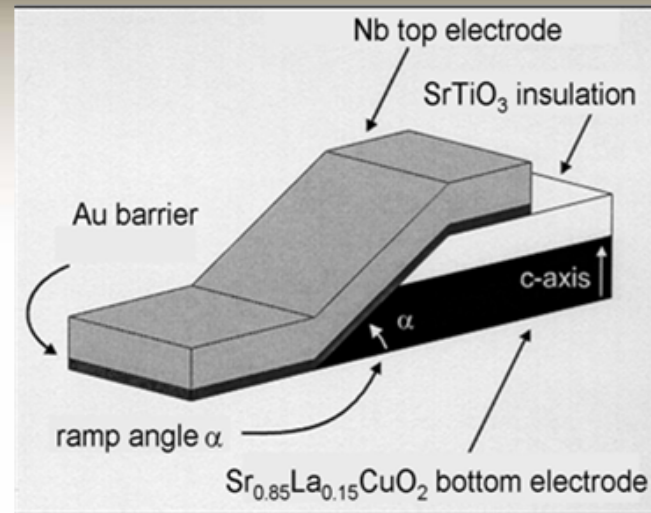
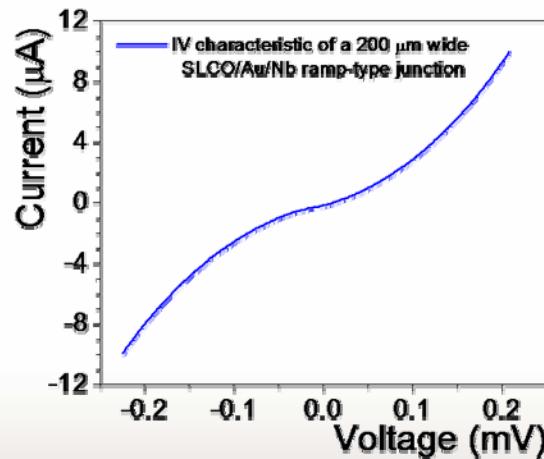
c)

*Tomaschko, Leca, Selistrovski,  
 Kleiner, Koelle, Phys. Rev. B 84 (2011)*

# $Sr_{1-x}La_xCuO_2$ ramp-type junctions – preliminary data

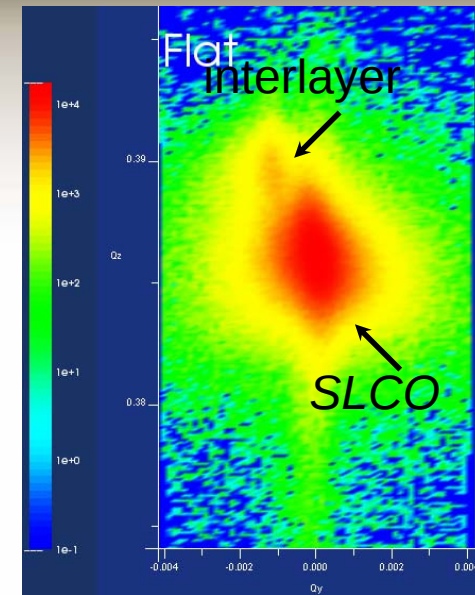


SEM image of a 200  $\mu\text{m}$  wide SLCO/Au/Nb ramp-type junction



Schematic representation of the SLCO/Au/Nb ramp-type junction  
(Smilde et al., APL 80)

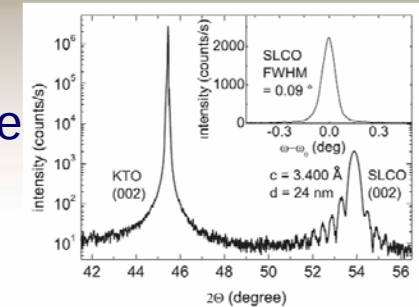
No Cooper pair tunneling observed  
- rough SLCO/Au interface



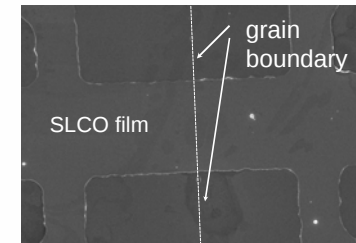
XRD rsm scan of (101) showing the separation of the SLCO and interlayer peaks

# Conclusions

- single-crystal like thin films of the electron-doped  $\text{Sr}_{1-x}\text{La}_x\text{CuO}_2$  compounds could be grown by PLD for  $x=0.15$ , but their superconducting properties (highest  $T_c$  of 25 K) are still far of those of the bulk or of the MBE grown films, but with better structural characteristics than the MBE films  $\Rightarrow$  improving  $T_c$



- epitaxial strain controls the final structural and transport properties of the films grown on  $\text{BaTiO}_3/\text{SrTiO}_3$  or  $\text{KTaO}_3$   $\Rightarrow$  new substrates (like  $\text{MeScO}_3$ )?



- first  $24^\circ$  [001] tilt grain boundary junctions were fabricated and their transport properties studied

- no transparency of the  $\text{Sr}_{1-x}\text{La}_x\text{CuO}_2/\text{Au}$  interface – no technology yet for the fabrication of the ramp-type  $\text{Sr}_{1-x}\text{La}_x\text{CuO}_2$  based junctions

